

LW Y1SG

Micro SIDELED® 2808

Micro SIDELED is a SMT LED with side emission. Due to its low package height it is ideal for applications in limited space environments.



Applications

- Electronic Equipment
- Gaming, Amusement, Gambling
- White Goods

Features:

- Package: white SMT package, colored diffused silicone resin
- Chip technology: InGaN on Sapphire
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.30, Cy = 0.28 acc. to CIE 1931 (• white)
- Optical efficacy: 45 lm/W
- Corrosion Robustness Class: 1B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information

Type	Luminous Intensity ¹⁾ $I_F = 20 \text{ mA}$ I_v	Ordering Code
LW Y1SG-BFOO-GKJM-1	$\geq 1600 \text{ mcd}$	Q65111A8460
LW Y1SG-BFOO-EKFM-1	$\geq 1600 \text{ mcd}$	Q65111A8461

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min.	-40 °C
		max.	85 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	100 °C
Junction Temperature	T_j	max.	95 °C
Forward current $T_A = 25\text{ °C}$	I_F	max.	30 mA
Surge Current $t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_A = 25\text{ °C}$	I_{FS}	max.	300 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV
Reverse voltage ²⁾	V_R		Not designed for reverse operation

Characteristics

$I_F = 20 \text{ mA}$; $T_A = 25 \text{ °C}$

Parameter	Symbol		Values
Chromaticity Coordinate ³⁾	Cx	typ.	0.30
	Cy	typ.	0.28
Viewing angle at 50 % I_v	2ϕ	typ.	120 °
Forward Voltage ⁴⁾ $I_F = 20 \text{ mA}$	V_F	min.	2.90 V
		typ.	3.30 V
		max.	3.60 V
Reverse current ²⁾	I_R		Not designed for reverse operation
Temperature Coefficient of Cx	TC_{Cx}	typ.	$-0.2 \cdot 10^{-3} / \text{K}$
Temperature Coefficient of Cy	TC_{Cy}	typ.	$-0.2 \cdot 10^{-3} / \text{K}$
Real thermal resistance junction/ambient ^{5), 6)}	$R_{thJA \text{ real}}$	max.	460 K / W
Real thermal resistance junction/solderpoint ⁵⁾	$R_{thJS \text{ real}}$	max.	240 K / W

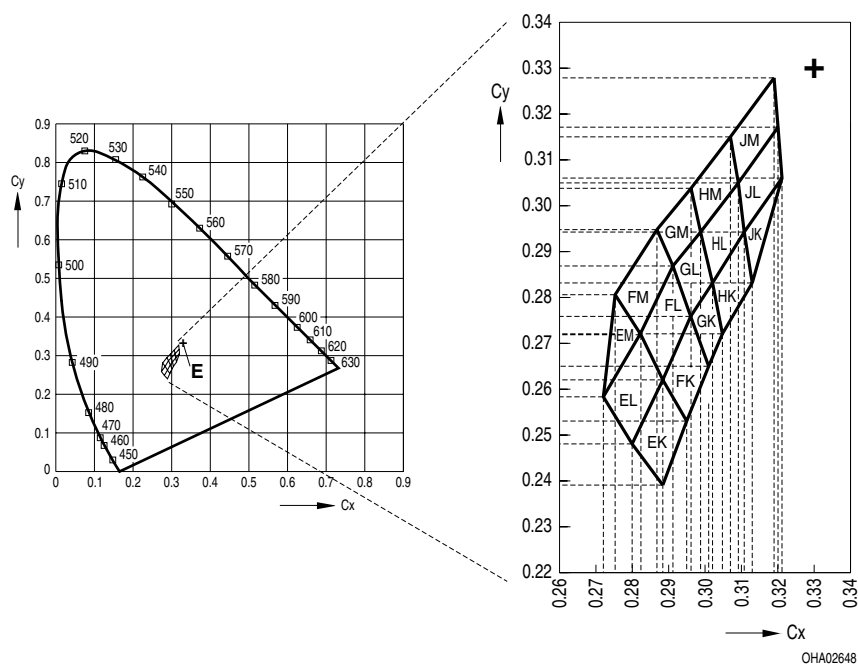
Brightness Groups

Group	Luminous Intensity ¹⁾ $I_F = 20 \text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 20 \text{ mA}$ max. I_v	Luminous Flux ⁷⁾ $I_F = 20 \text{ mA}$ typ. Φ_v
BF	1600 mcd	1800 mcd	5100 mlm
CE	1800 mcd	2000 mcd	5700 mlm
CF	2000 mcd	2200 mcd	6300 mlm
DE	2200 mcd	2400 mcd	6900 mlm
DF	2400 mcd	2600 mcd	7500 mlm
EE	2600 mcd	2800 mcd	8100 mlm

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ $I_F = 20 \text{ mA}$ min. V_F	Forward Voltage ⁴⁾ $I_F = 20 \text{ mA}$ max. V_F
4	2.90 V	3.20 V
5	3.20 V	3.60 V

Chromaticity Coordinate Groups



Color Chromaticity Groups ³⁾

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
EK	0.2800	0.2480	FL	0.2820	0.2720	GM	0.2870	0.2950
	0.2880	0.2390		0.2880	0.2620		0.2910	0.2870
	0.2880	0.2620		0.2910	0.2870		0.2960	0.3040
	0.2950	0.2530		0.2960	0.2760		0.2990	0.2940
EL	0.2720	0.2580	FM	0.2750	0.2810	HK	0.3020	0.2830
	0.2800	0.2480		0.2820	0.2720		0.3050	0.2720
	0.2820	0.2720		0.2870	0.2950		0.3110	0.2940
	0.2880	0.2620		0.2910	0.2870		0.3130	0.2830
EM	0.2720	0.2580	GK	0.2960	0.2760	HL	0.2990	0.2940
	0.2750	0.2810		0.3010	0.2650		0.3020	0.2830
	0.2820	0.2720		0.3020	0.2830		0.3090	0.3050
	0.2820	0.2720		0.3050	0.2720		0.3110	0.2940
FK	0.2880	0.2620	GL	0.2910	0.2870	HM	0.2960	0.3040
	0.2950	0.2530		0.2960	0.2760		0.2990	0.2940
	0.2960	0.2760		0.2990	0.2940		0.3070	0.3150
	0.3010	0.2650		0.3020	0.2830		0.3090	0.3050

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
JK	0.3110	0.2940	JL	0.3090	0.3050	JM	0.3070	0.3150
	0.3130	0.2830		0.3110	0.2940		0.3090	0.3050
	0.3210	0.3060		0.3200	0.3170		0.3190	0.3280
				0.3210	0.3060		0.3200	0.3170

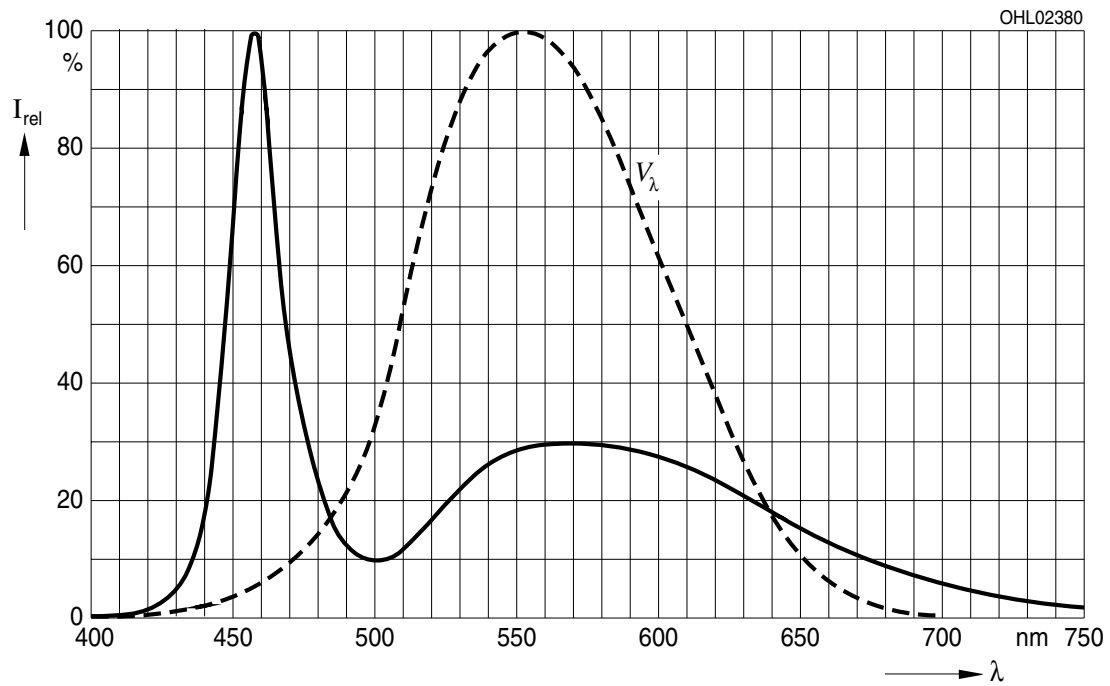
Group Name on Label

Example: BF-EK-4

Brightness	Color chromaticity	Forward Voltage
BF	EK	4

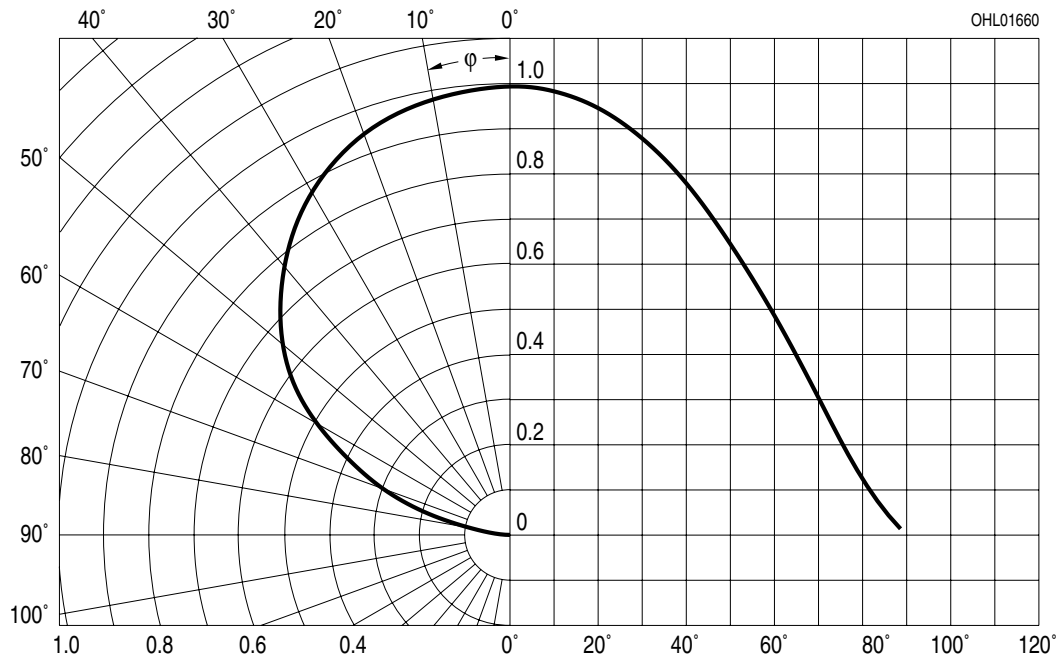
Relative Spectral Emission ⁷⁾

$$I_{\text{rel}} = f(\lambda); I_F = 20 \text{ mA}; T_A = 25^\circ \text{C}$$



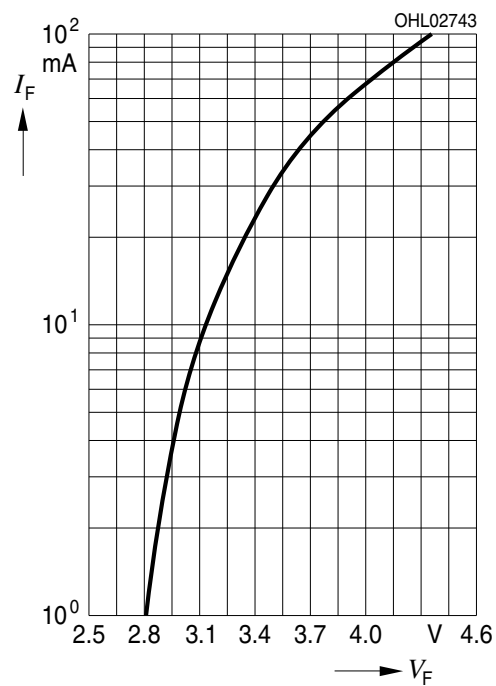
Radiation Characteristics ⁷⁾

$$I_{\text{rel}} = f(\phi); T_A = 25^\circ \text{C}$$

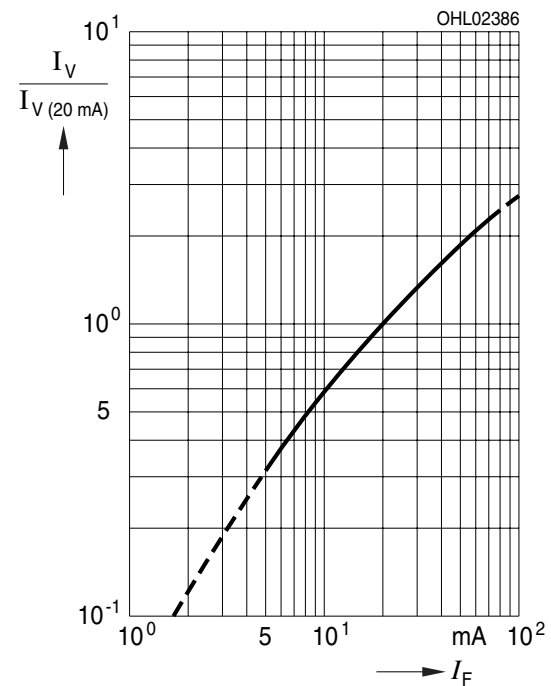


Forward current ^{7), 8)}

$$I_F = f(V_F); T_A = 25\text{ °C}$$

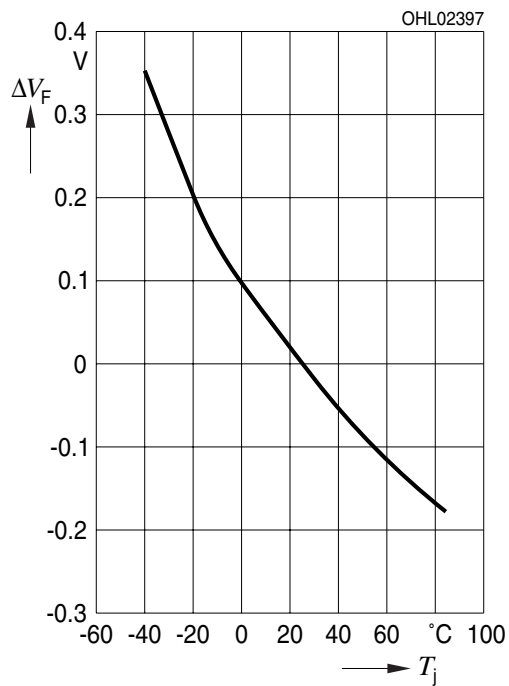
**Relative Luminous Intensity** ^{7), 8)}

$$I_V/I_V(20\text{ mA}) = f(I_F); T_A = 25\text{ °C}$$

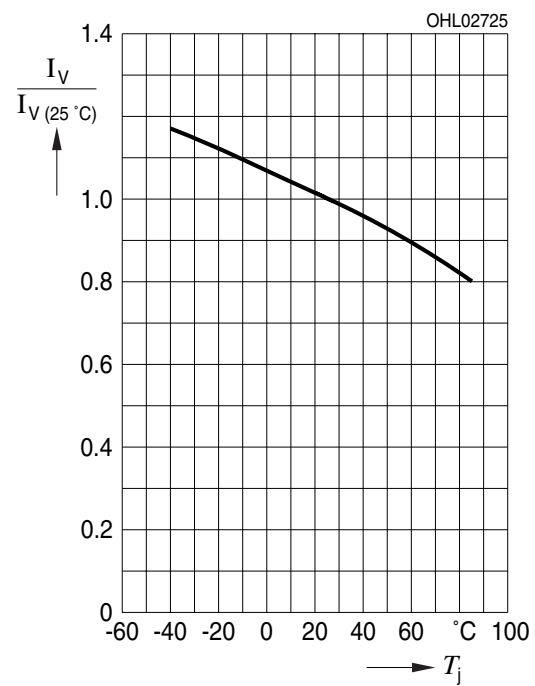


Forward Voltage ⁷⁾

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 20\text{ mA}$$

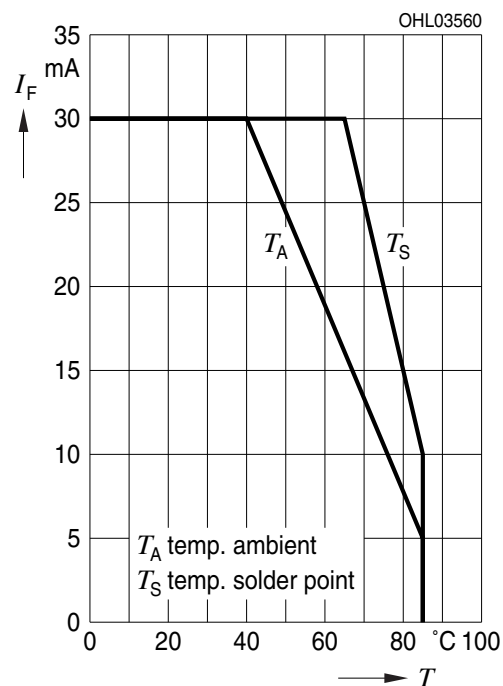
**Relative Luminous Intensity** ⁷⁾

$$I_V/I_V(25^\circ\text{C}) = f(T_j); I_F = 20\text{ mA}$$



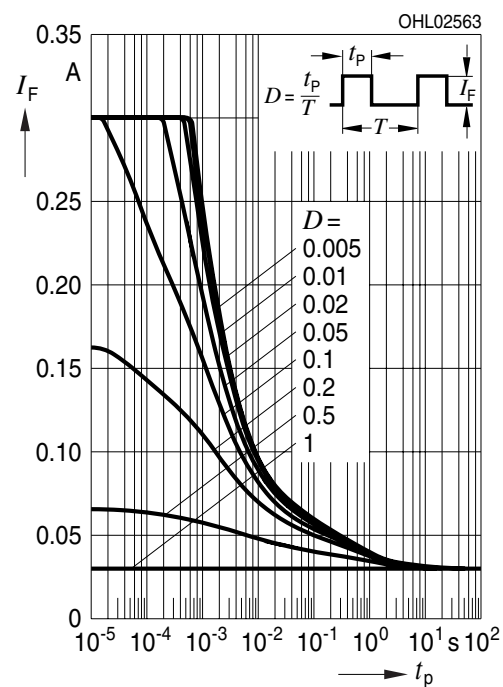
Max. Permissible Forward Current

$$I_F = f(T)$$



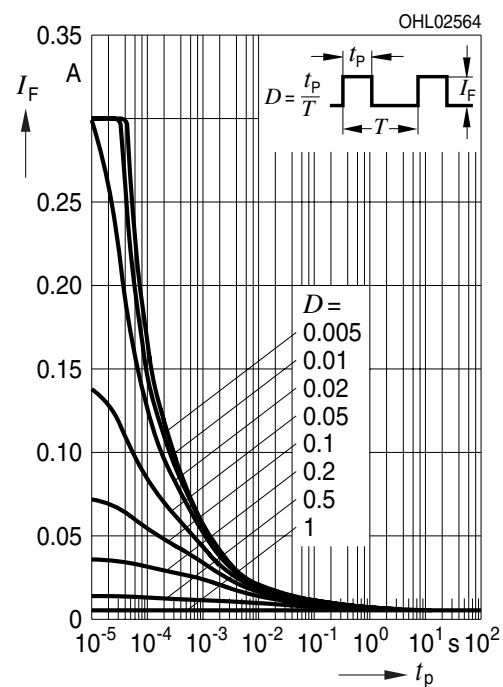
Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_A = 25^\circ\text{C}$$

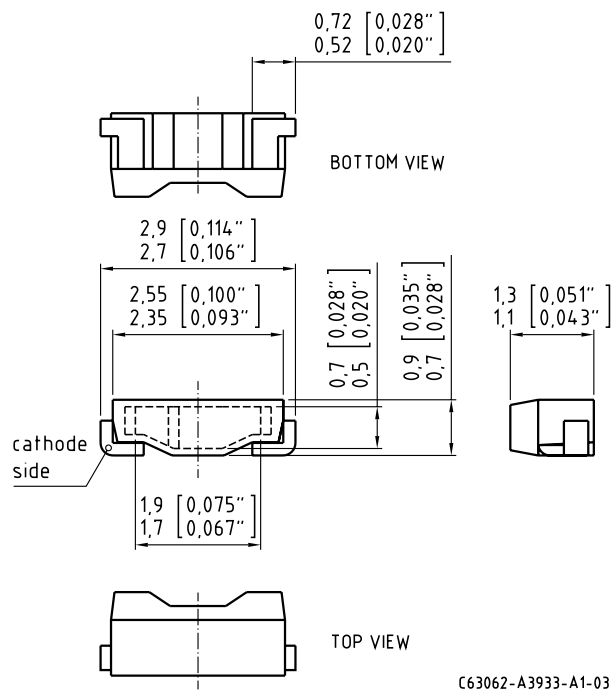


Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_A = 85^\circ\text{C}$$



Dimensional Drawing ⁹⁾



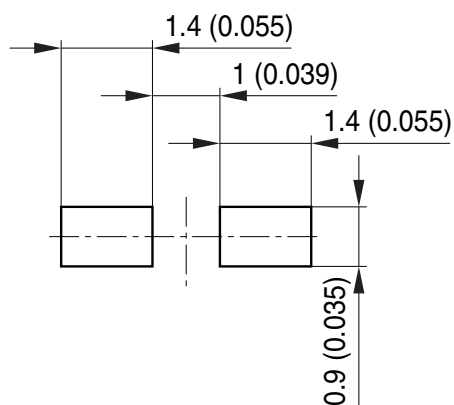
Approximate Weight:

5.0 mg

Corrosion test:

Class: 1B

Test condition: 25°C / 75 % RH / 200ppb SO₂, 200ppb NO₂, 10ppb H₂S, 10ppb Cl₂ / 21 days (EN 60068-2-60 (Method 4))

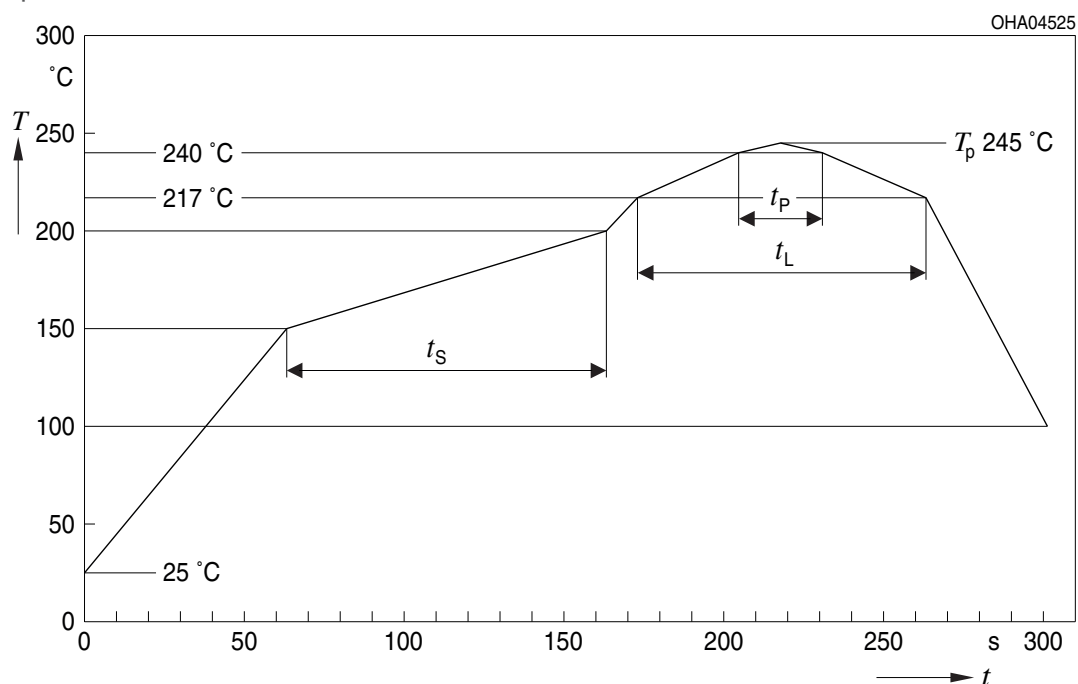
Recommended Solder Pad ⁹⁾

OHLPY944

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

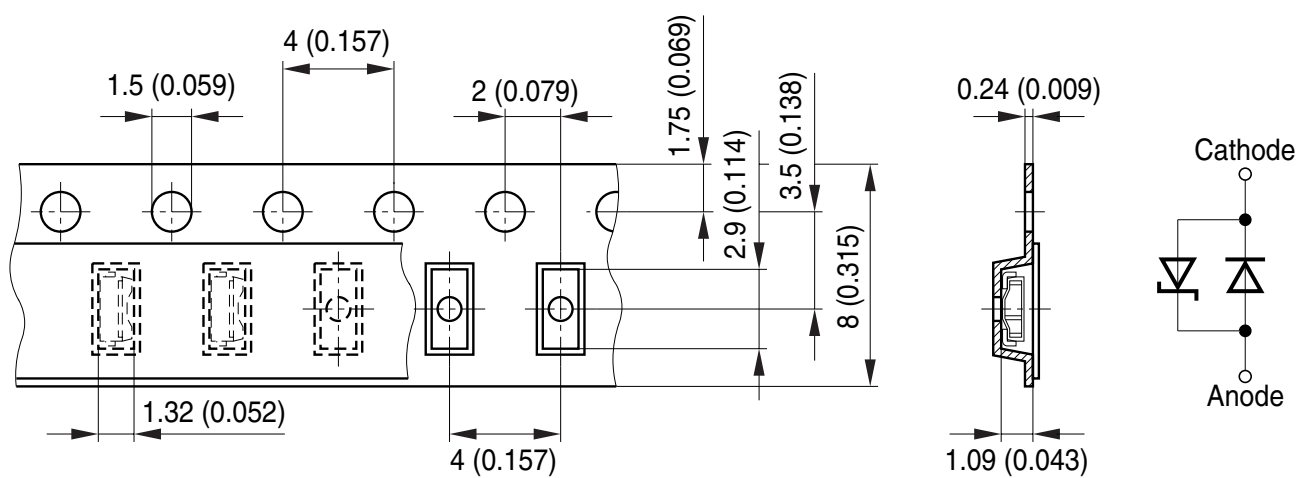
Product complies to MSL Level 4 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		$^{\circ}\text{C}$
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	$^{\circ}\text{C}$
Time within 5 °C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

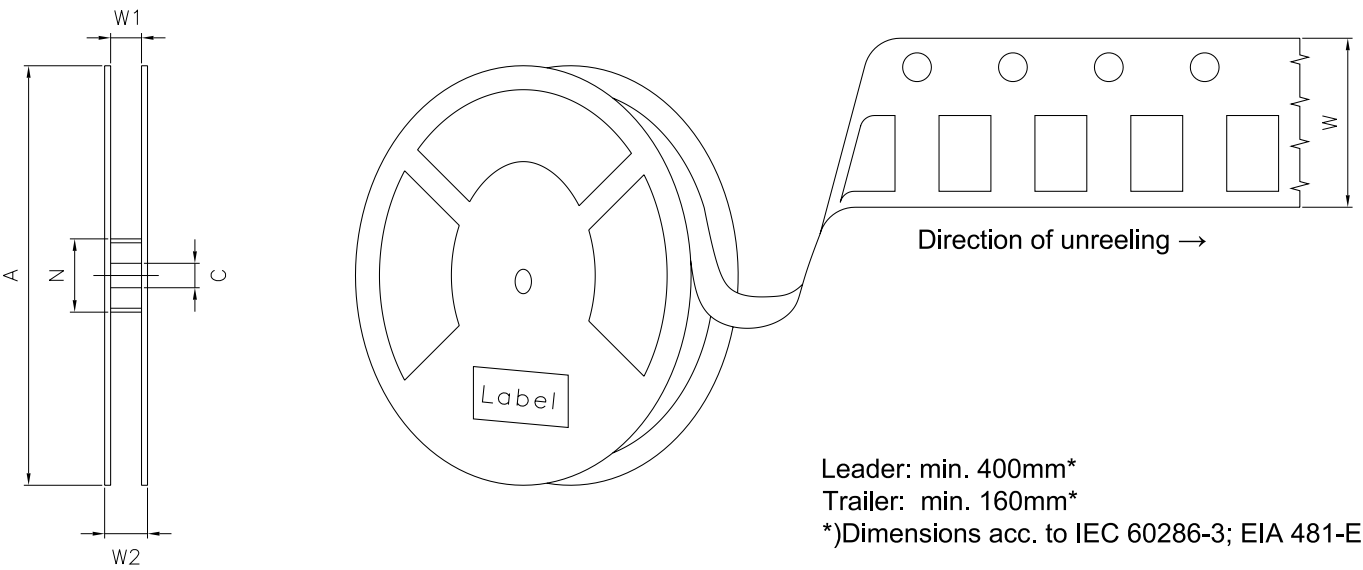
All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T -range

Taping ⁹⁾

OHAY2128

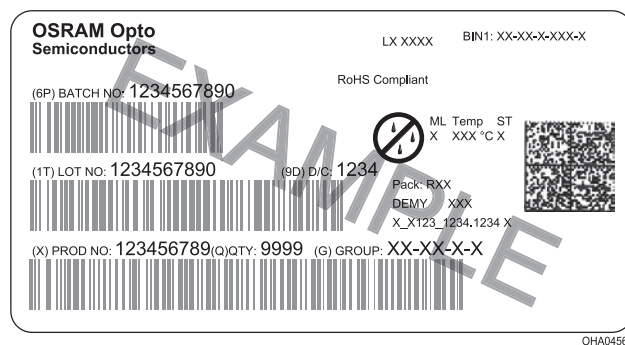
Tape and Reel ¹⁰⁾



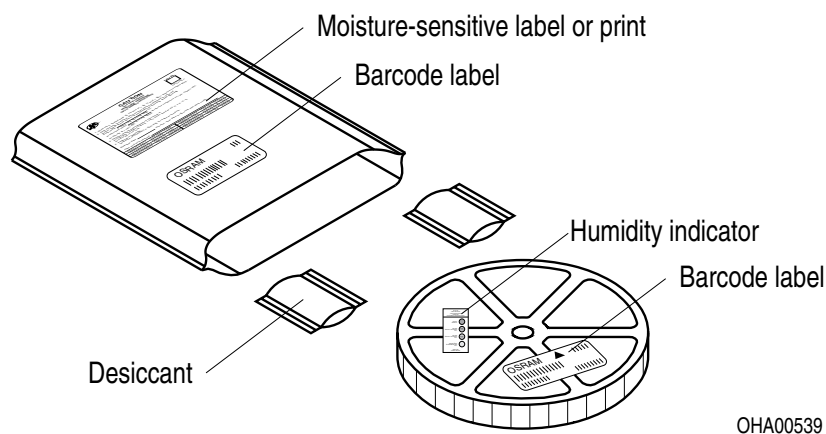
Reel dimensions [mm]

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	2000

Barcode-Product-Label (BPL)

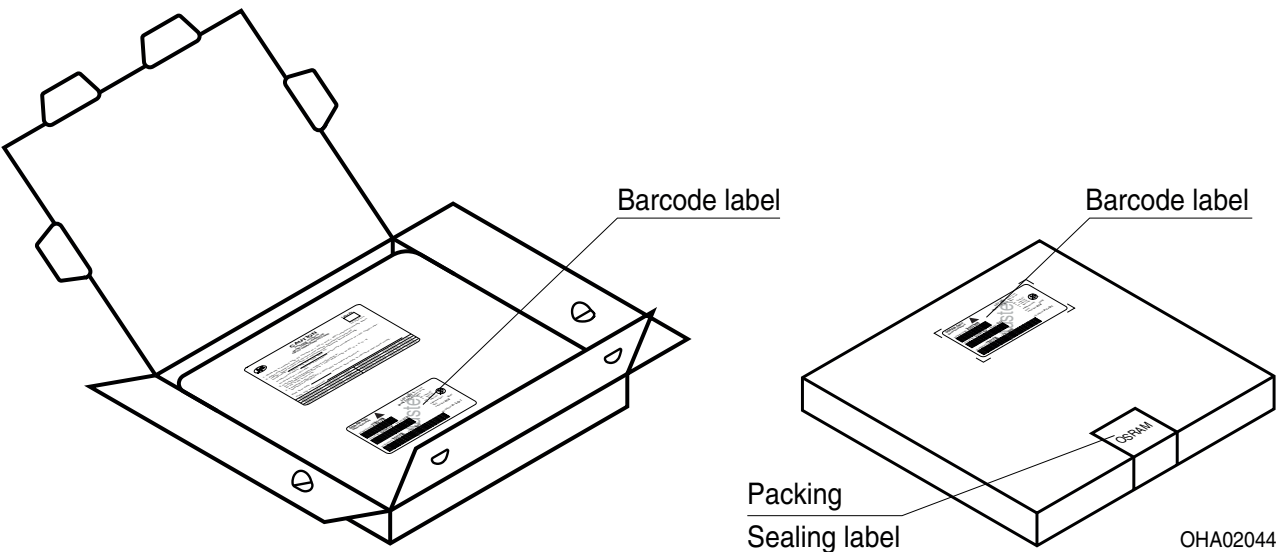


Dry Packing Process and Materials ⁹⁾



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Transportation Packing and Materials ⁹⁾



Dimensions of transportation box in mm

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the LED specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. As is also true when viewing other bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this LED contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize LED exposure to aggressive substances during storage, production, and use. LEDs that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes

Disclaimer

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

In case Buyer – or Customer supplied by Buyer– considers using OSRAM OS components in product safety devices/applications or medical devices/applications, Buyer and/or Customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and Buyer and /or Customer will analyze and coordinate the customer-specific request between OSRAM OS and Buyer and/or Customer.

Glossary

- 1) **Brightness:** Brightness groups are tested at a current pulse duration of 25 ms and a tolerance of $\pm 11\%$.
- 2) **Reverse Operation:** Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.
- 3) **Chromaticity coordinate groups:** Chromaticity coordinate groups are tested at a current pulse duration of 25 ms and a tolerance of ± 0.01 .
- 4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ± 0.1 V.
- 5) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 6) **Thermal Resistance:** R_{thJA} results from mounting on PC board FR 4 (pad size 16 mm² per pad)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single LEDs within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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EU RoHS and China RoHS compliant product



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按照中国的相关法规和标准，不含有毒有害物质或元素。